IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:	Yue Kuo
Serial No.:	09 736,043
Filing Date:	December 12, 2000
Group Art Unit:	2823
Examiner:	William D. Coleman
Title:	SEMICONDUCTOR CONDUCTIVE PATTERN FORMATION METHOD

Applicants transmit herewith an Amendment in the above-identified application. An additional filing fee has been calculated as shown below.

	CLAIMS AFTER AMENDMENT		NUMBER PREVIOUSLY PAID FOR	EXTRA	RATE	ADDITIONAL FEE
Total Claims:	32	-	30	2	x $ 9 =	$ 18.00
Independent Claims:	5		3	2	x $ 42 =	$ 84.00
			TOTAL ADDITIONAL FEE FOR THIS AMENDMENT			$ 102.00

Enclosed is a check in the amount of $102.00 to satisfy filing fee requirements under 37 C.F.R. §1.16. Please credit any overpayment, or charge any additional fee required by this paper, to Deposit Account No. 02-0384 of BAKER BOTTS L.L.P.

Respectfully submitted,

BAKER BOTTS L.L.P.
Attorneys for Applicants

Bradley P. Williams
Reg. No. 40,227

Date: _____

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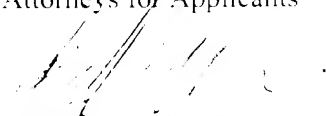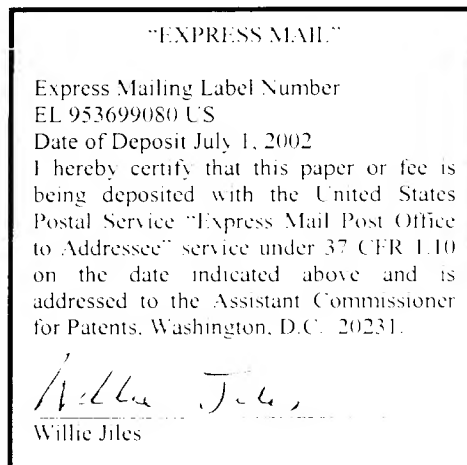Title: SEMICONDUCTOR CONDUCTIVE PATTERN

                                  FORMATION METHOD

Honorable Assistant Commissioner

 for Patents

Washington, D.C.   20231

> "EXPRESS MAIL"
>
> Express Mailing Label Number
> EL 953699080 US
> Date of Deposit July 1, 2002
> I hereby certify that this paper or fee is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and is addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.
>
> Willie Jiles

Dear Sir:

RESPONSE TO OFFICE ACTION

     In response to the Office Action mailed February 21, 2002, Applicant respectfully requests the Examiner to reconsider the rejection of the claims in view of the following amendments to the claims and the comments as set forth below. Please amend the application as follows: